

SN74ALVCH16270

12-BIT TO 24-BIT REGISTERED BUS EXCHANGER WITH 3-STATE OUTPUTS

SCES028C – JULY 1995 – REVISED JULY 1997

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 12-bit to 24-bit registered bus exchanger is designed for 2.3-V to 3.6-V V_{CC} operation.

The SN74ALVCH16270 is used in applications where data must be transferred from a narrow high-speed bus to a wide lower-frequency bus.

The device provides synchronous data exchange between the two ports. Data is stored in the internal registers on the low-to-high transition of the clock (CLK) input when the appropriate \overline{CLKEN} inputs are low. The select (SEL) line selects 1B or 2B data for the A outputs. For data transfer in the A-to-B direction, a two-stage pipeline is provided in the A-to-1B path, with a single storage register in the A-to-2B path.

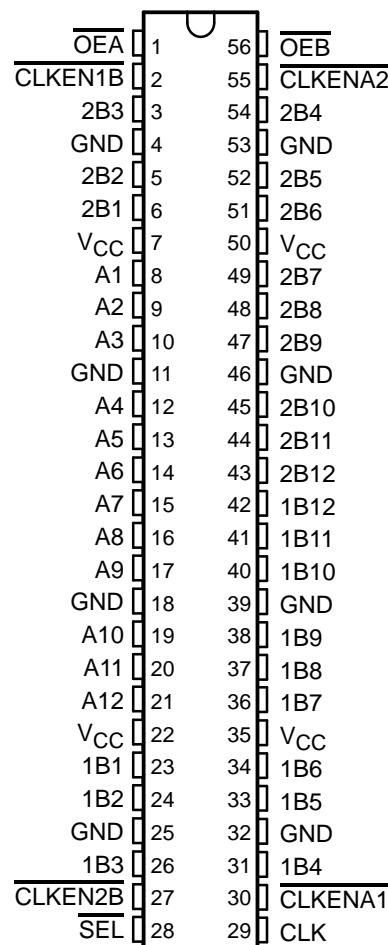
Proper control of the \overline{CLKENA} inputs allows two sequential 12-bit words to be presented synchronously as a 24-bit word on the B port. Data flow is controlled by the active-low output enables (\overline{OEA} , \overline{OEB}). The control terminals are registered to synchronize the bus-direction changes with CLK.

To ensure the high-impedance state during power up or power down, a clock pulse should be applied as soon as possible and \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. Due to \overline{OE} being routed through a register, the active state of the outputs cannot be determined prior to the arrival of the first clock pulse.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16270 is characterized for operation from -40°C to 85°C .

DGG OR DL PACKAGE
(TOP VIEW)



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Function Tables

OUTPUT ENABLE

INPUTS			OUTPUTS	
CLK	\overline{OEA}	\overline{OEB}	A	1B, 2B
↑	H	H	Z	Z
↑	H	L	Z	Active
↑	L	H	Active	Z
↑	L	L	Active	Active

A-TO-B STORAGE ($\overline{OEB} = L$)

INPUTS				OUTPUTS	
$\overline{CLKENA1}$	$\overline{CLKENA2}$	CLK	A	1B	2B
L	H	↑	L	L [†]	2B ₀ [‡]
L	H	↑	H	H [†]	2B ₀ [‡]
L	L	↑	L	L [†]	L
L	L	↑	H	H [†]	H
H	L	↑	L	1B ₀ [‡]	L
H	L	↑	H	1B ₀ [‡]	H
H	H	X	X	1B ₀ [‡]	2B ₀ [‡]

[†] Two CLK edges are needed to propagate data.

[‡] Output level before the indicated steady-state input conditions were established

B-TO-A STORAGE ($\overline{OEA} = L$)

INPUTS						OUTPUT A
$\overline{CLKEN1B}$	$\overline{CLKEN2B}$	CLK	\overline{SEL}	1B	2B	
H	X	X	H	X	X	A ₀ [‡]
X	H	X	L	X	X	A ₀ [‡]
L	X	↑	H	L	X	L
L	X	↑	H	H	X	H
X	L	↑	L	X	L	L
X	L	↑	L	X	H	H

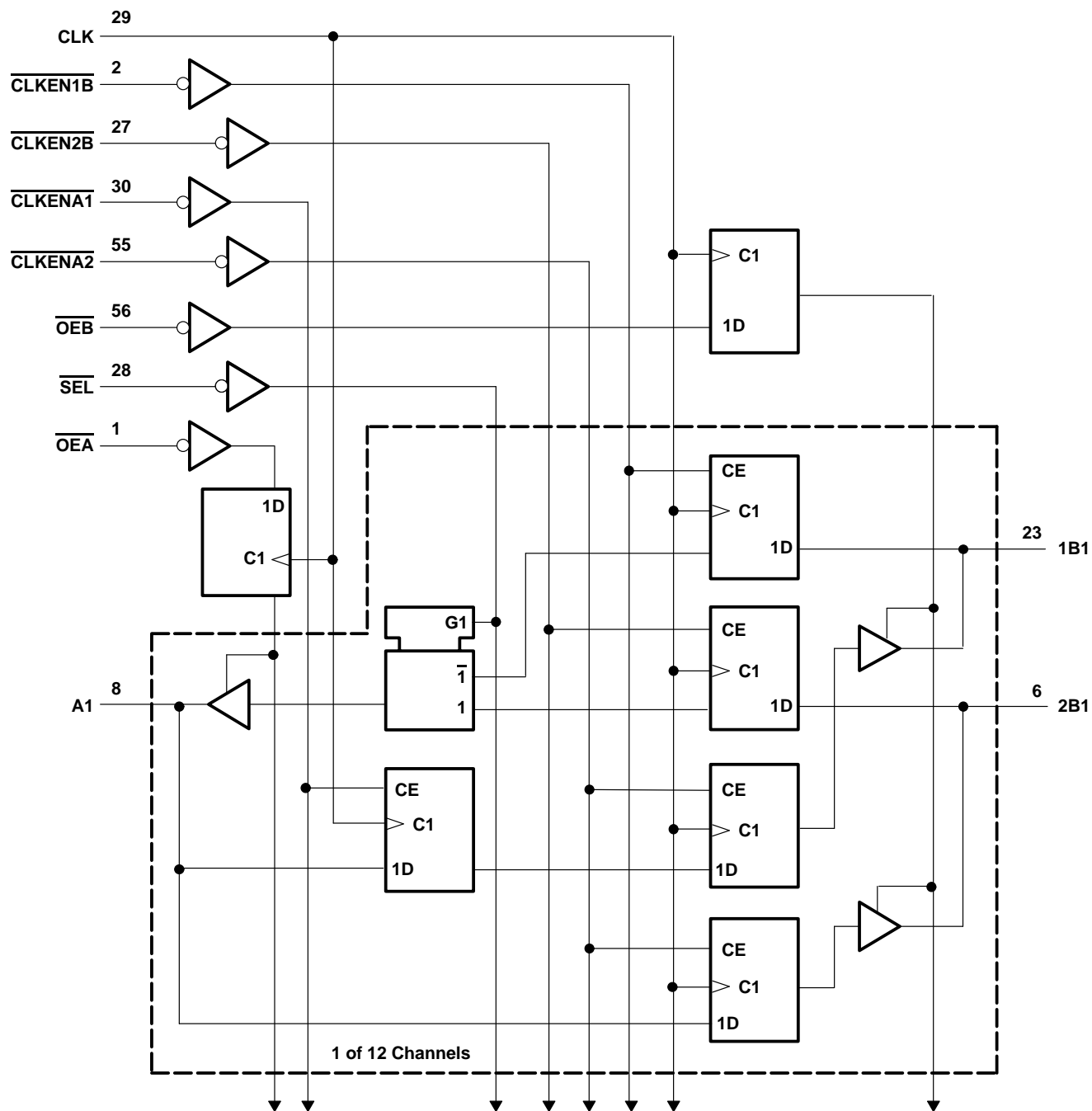
[‡] Output level before the indicated steady-state input conditions were established

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I : Except I/O ports (see Note 1)	–0.5 V to 4.6 V
I/O ports (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	2.3	3.6	V
V_{IH}	High-level input voltage	$V_{CC} = 2.3$ V to 2.7 V 1.7		V
		$V_{CC} = 2.7$ V to 3.6 V 2		
V_{IL}	Low-level input voltage	$V_{CC} = 2.3$ V to 2.7 V 0.7		V
		$V_{CC} = 2.7$ V to 3.6 V 0.8		
V_I	Input voltage	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2.3$ V –12		mA
		$V_{CC} = 2.7$ V –12		
		$V_{CC} = 3$ V –24		
I_{OL}	Low-level output current	$V_{CC} = 2.3$ V 12		mA
		$V_{CC} = 2.7$ V 12		
		$V_{CC} = 3$ V 24		
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_A	Operating free-air temperature	–40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = –100 µA	2.3 V to 3.6 V	V _{CC} – 0.2			V
		I _{OH} = –6 mA, V _{IH} = 1.7 V	2.3 V	2			
		V _{IH} = 1.7 V	2.3 V	1.7			
		I _{OH} = –12 mA, V _{IH} = 2 V	2.7 V	2.2			
			3 V	2.4			
		I _{OH} = –24 mA, V _{IH} = 2 V	3 V	2			
V _{OL}		I _{OL} = 100 µA	2.3 V to 3.6 V			0.2	V
		I _{OL} = 6 mA, V _{IL} = 0.7 V	2.3 V			0.4	
		V _{IL} = 0.7 V	2.3 V			0.7	
		I _{OL} = 12 mA, V _{IL} = 0.8 V	2.7 V			0.4	
			3 V			0.55	
		I _{OL} = 24 mA, V _{IL} = 0.8 V	3 V			0.55	
I _I		V _I = V _{CC} or GND	3.6 V			±5	µA
I _I (hold)		V _I = 0.7 V	2.3 V	45			µA
		V _I = 1.7 V	2.3 V	–45			
		V _I = 0.8 V	3 V	75			
		V _I = 2 V	3 V	–75			
		V _I = 0 to 3.6 V†	3.6 V			±500	
I _{OZ} §		V _O = V _{CC} or GND	3.6 V			±10	µA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	3.6 V			40	µA
ΔI _{CC}		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	3 V to 3.6 V			750	µA
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V	3.5			pF
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V	9			pF

† All typical values are measured at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	0	150	0	150	0	150	MHz
t _w	Pulse duration, CLK high or low	3.3		3.3		3.3		ns
t _{su}	A data before CLK↑	4.1		3.8		3.1		ns
	B data before CLK↑	0.9		1.2		0.9		
	CLKENA1 or CLKENA2 before CLK↑	3.5		3.2		2.7		
	CLKEN1B or CLKEN2B before CLK↑	3.4		3		2.6		
	OE data before CLK↑	4.4		3.9		3.2		
t _h	A data after CLK↑	0		0		0.2		ns
	B data after CLK↑	1.4		1		1.7		
	CLKENA1 or CLKENA2 after CLK↑	0		0.1		0.3		
	CLKEN1B or CLKEN2B after CLK↑	0		0		0.6		
	OE after CLK↑	0		0		0.1		



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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}			150		150		150		MHz
t_{pd}	CLK	B	2	6.5	5.8		1.1	5.1	ns
		A	1.7	6	5.4		1	4.7	
	\overline{SEL}	A	1.9	6.8	6.4		1	5.5	
t_{en}	CLK	A or B	1.6	7.5	6.8		1	6	ns
t_{dis}	CLK	A or B	2.6	7.4	6.5		1.1	5.8	ns

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	
C _{pd}	Power dissipation capacitance	Outputs enabled	C _L = 50 pF, f = 10 MHz	87	120	pF
		Outputs disabled		80.5	118	

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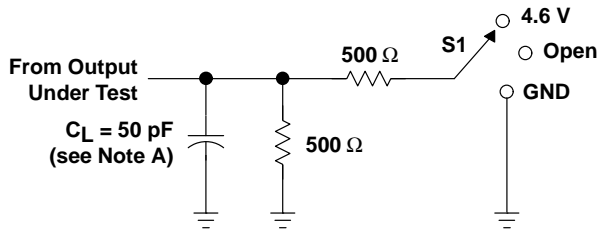
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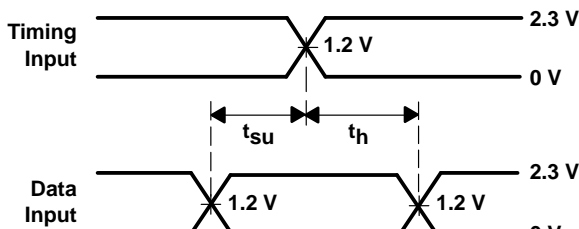
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

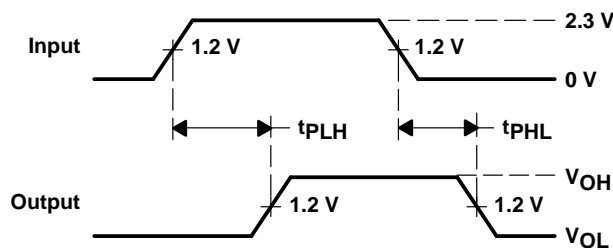


LOAD CIRCUIT

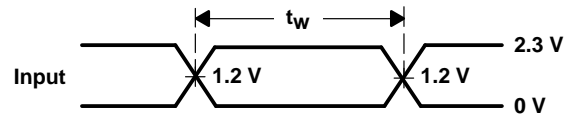
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	4.6 V
t_{PHZ}/t_{PZH}	GND



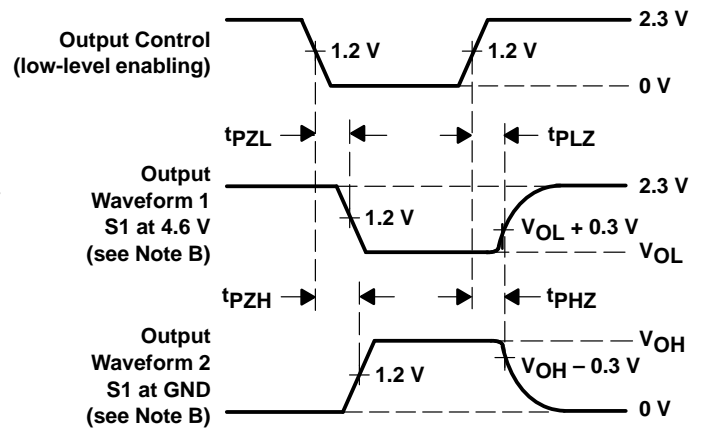
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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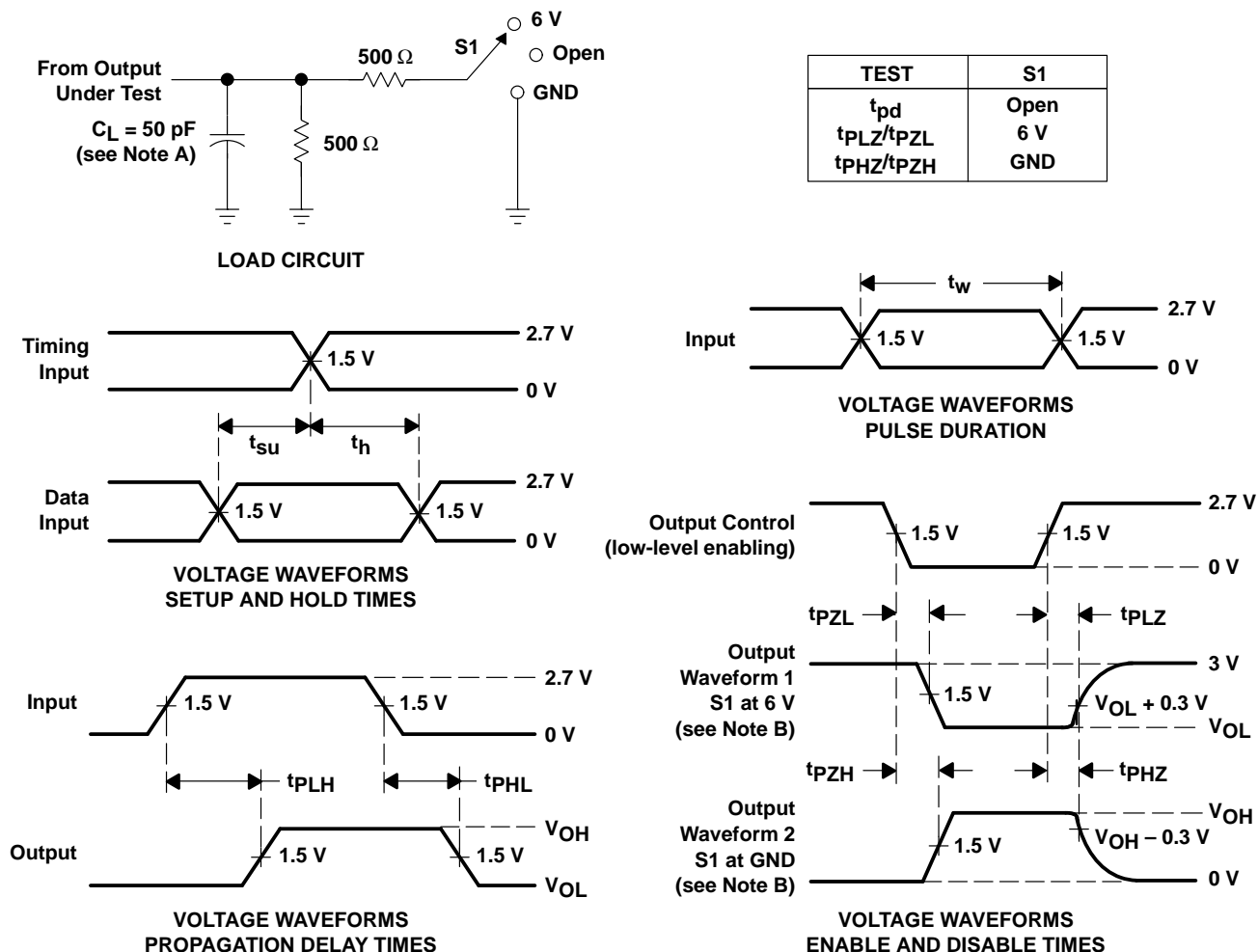
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PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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